

Implementation of TF3 Solid State Detectors

Thursday 23 March 2023

Interconnect and device fabrication technologies - 222/R-001 (11:30 - 13:20)

time	[id] title	presenter
11:30	[37] WG7: Introduction and analysis	CALDERINI, Giovanni
11:40	[38] WP7: In-house interconnection technologies	DANNHEIM, Dominik
11:50	[39] WP7: Interconnection technologies via specialised vendors	HUEGGING, Fabian HUEGGING, Fabian
12:00	[40] WP7: Discussion	ALL